

Product / Process Change Notice

No.: Z200-PCN-DM202404-01-A Date: April 16, 2024 Change Title: 4Gb (256Mb x16 and 512Mb x8) DDR3/ DDR3L technology migration from 25snm to 20nm. Change Classification: ☑ Major ☐ Minor with customer notification ☐ Minor without customer notification Change item: ☐ DataSheet ☐ Design ☐ Raw Material ☐ Wafer FAB ☐ Assembly ☐ Testing ☐ Packing ☐ Manufacture site <a> Others Affected Product(s): Please refer to Table 1 in details. Description of Change(s) Technology migration (25snm to 20nm) for 4Gb DDR3/DDR3L. Reason for Change(s): According to Winbond product roadmap, a new 4Gb DDR3/DDR3L using the 20nm process was launched. Impact of Change(s): (positive & negative) Form: No Change Fit: No Change (Please refer to attachment I) Function: No Concern (Compatible between 25snm and 20nm, Please refer to attachment II) Reliability: No Concern (Please refer to attachment III) Hazardous Substances: No Concern (Please refer to attachment IV and V) Qualification Plan/ Results : Based on Winbond reliability report, the new product meets our criteria and no quality concern (refer to attachment III in details) Implementation Plan: The follow-up disposition of 25snm 256Mb x16 & 512Mb x8 DDR3: 1) The date of last-buy orders for 25snm 256Mb x16 & 512Mb x8 DDR3: Nov 1, 2024 2) The last shipment date of 25snm 256Mb x16 & 512Mb x8 DDR3: Feb 1,2025 ■ Date Code: ☑ Proposed first ship date: August 01, 2024 onward ■ Lot No: onward Originator: Approval: (QA Approval: (QRA Director) (QA) YNuowq Dept. Manager) Name: <u>Betty Huang</u> TEL:<u>886-3-5678168</u> (ext.76549) FAX: <u>886-3-5796124</u> Address: No. 8, Keya 1st Rd., Daya Dist., Central Taiwan Science Park, Taichung **Contact for Questions** City 42881, Taiwan & Concerns

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Customer Comments:

Note: Please sign this notice, and return to Winbond contact within **30** days. If no response is received within **30** days, this Change Request will be assumed to meet your approval.

Change request will be assumed t	e title y can elele crem					
Major change: □ Approval	□ Disapproval	□ Conditional Approval :				
Minor change with customer notification: □ Recognition						
Minor change without customer notification: □ Approval □ Disapproval						
□ Conditional Approval :						
Comment:						
Date:						
Dept. name:						
Person in charge:		<u> </u>				

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Table 1. The affected part no is listed below.

W634GU6QB11J	W634GU6QB09I	W634GU6QB11I	W634GU8QB-09	W634GU8QB-12
W634GU6QB-12	W634GU6QB09J	W634GU6QB-09	W634GU8QB09I	W634GU8QB-11
W634GU6QB12I	W634GU6QB-11	W634GU8QB12I	W634GU8QB11I	W634GU8QB12I

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